

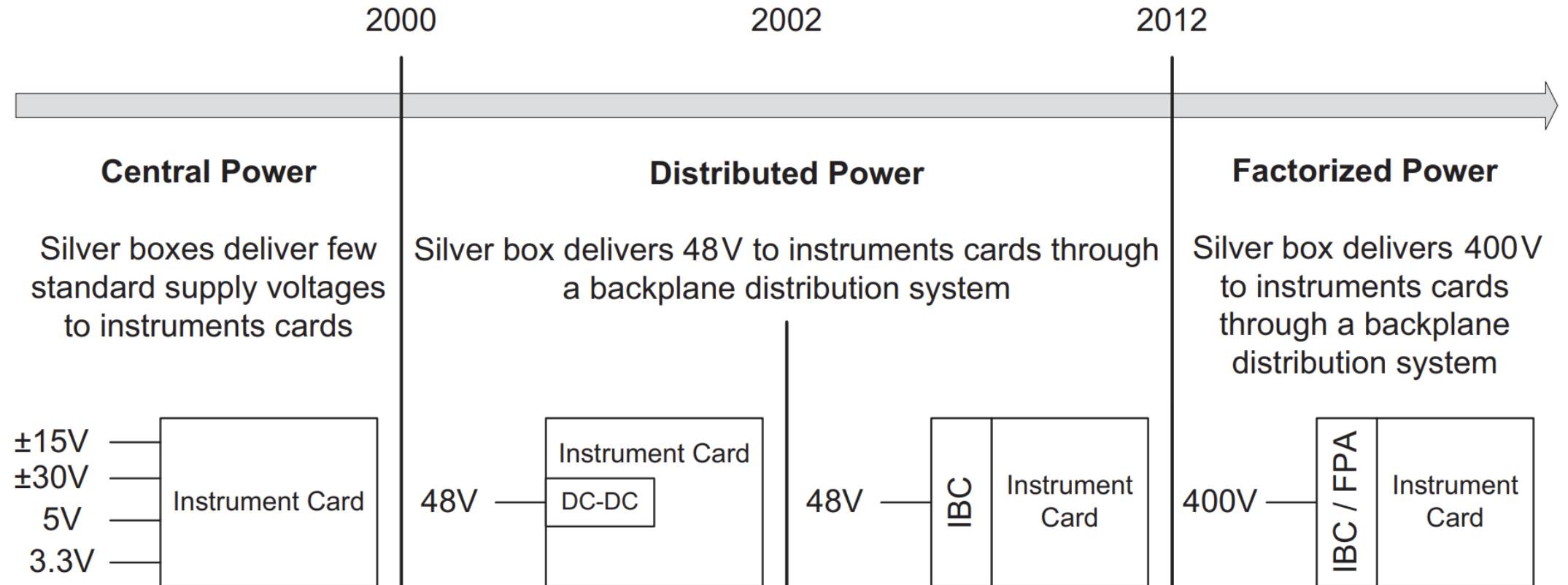


High density DC-DC power modules maximize ATE throughput

Vicor

Dec 2025

ATE power evolution



Challenge

- 400V IBC/FPA isolation in cards while keep small PCB size
- How to handle high heat flux density.
- Noise suppression becomes harder to handle while the power is increasing a lot

Design tradeoffs

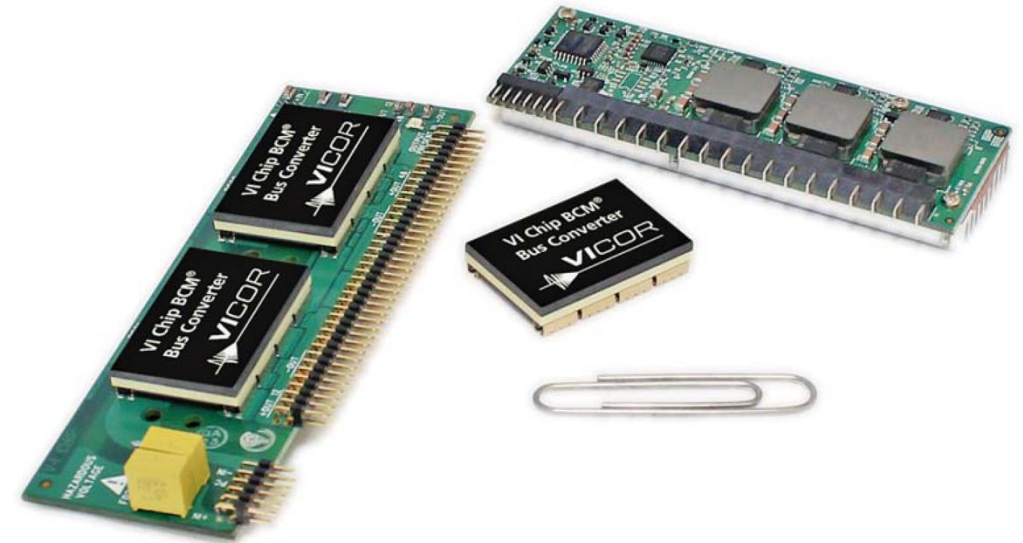
Objective	Primary Lever
Minimize BOM	Raise backplane voltage (↓ copper)
Optimize Thermals	Reduce current → 400 V preferred > 80 kW
Maximize Flexibility	IBA: 400/48 → 12 V intermediate → POL Bucks
Ensure Reliability	De-rate, redundant modules, hot-swap, telemetry
Control EMI	Local filtering, confine switching loops

Power vs. voltage guideline

Backplane or intermediate distribution DC voltage	Optimal Power Range
12V	Up to 5kW
48V	4 – 80kW
380V	Greater than 80kW

Reference implementation

- 400 V input card (left)
- 400-to-12 V BCM bus converter (center)
- Multi-phase 12V buck VRM placed at load (right)



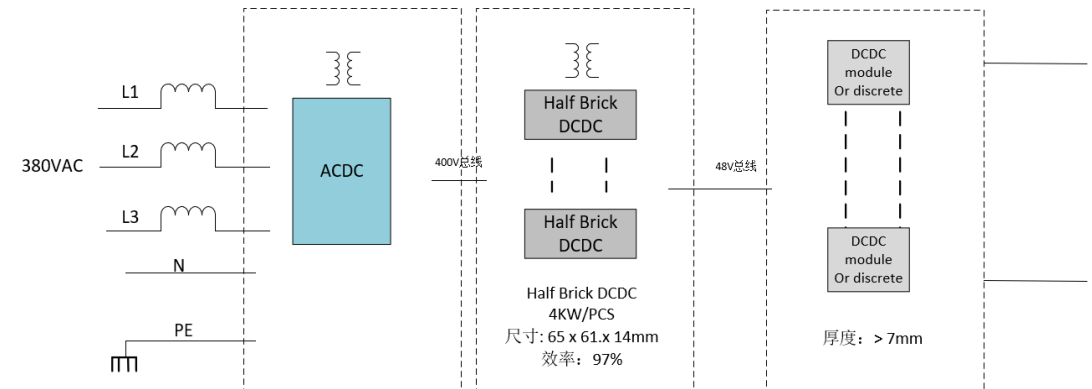
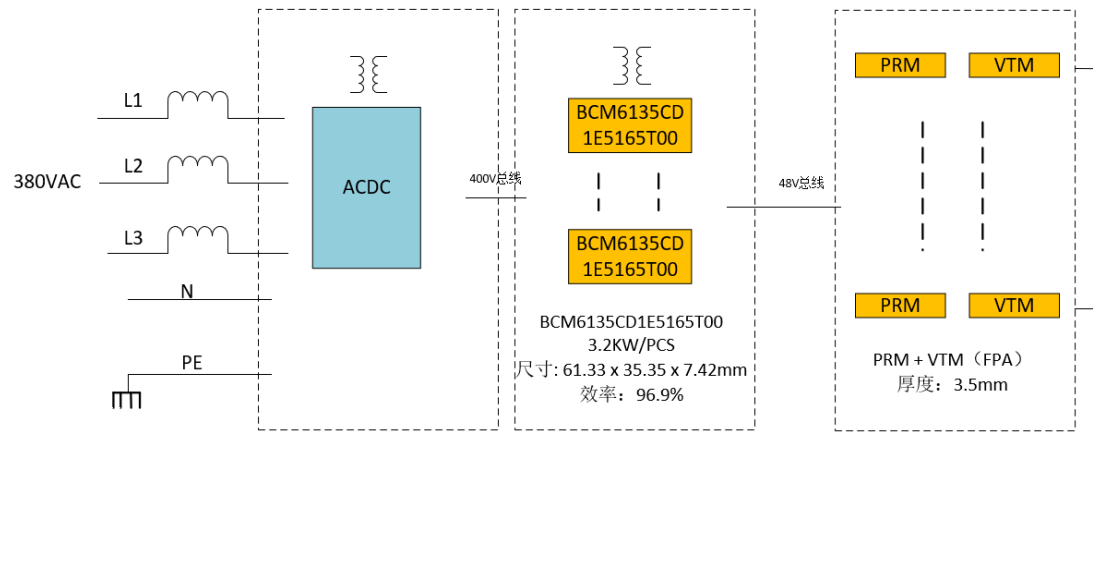
Result: >95% path efficiency, 50% copper reduction vs. 48V

The most advanced ATE – real case

- Double the test density in the same volume
- Upgrade the bus voltage from 48V to 400V
- A single DPS card meets all power requirements
- Power supply from mA level to kA level
- Ultra-thin board: the thickness of the power module is aligned with that of the FPGA

A complete solution from a high voltage bus to a secondary power supply

Vicor solution power density is 250% higher than competitor

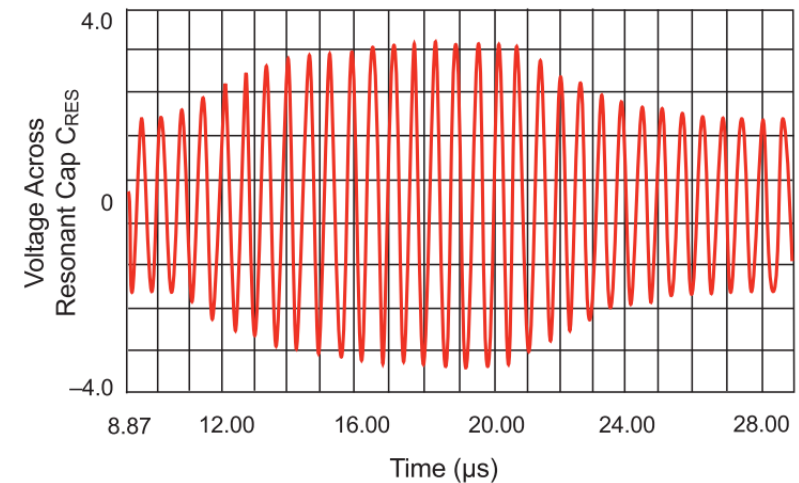
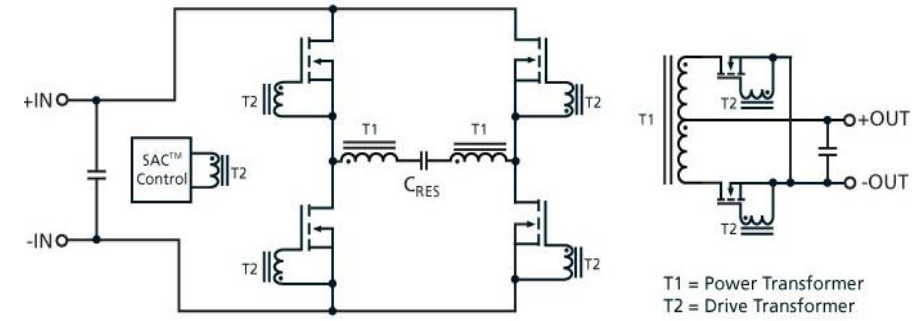


How Vicor achieves these features

- SAC technology
 - N:1 fix ratio DCDC bus converter
 - Sine wave
 - Excellent EMC performance
- ZVS phase shift buck-boost
 - Minimum the inductor current
 - ZVS for high side MOSFET
- FPA structure
 - Decrease the power loss in PCB
 - Improve the total power structure efficiency
- Advanced manufacturing process ensures product consistency

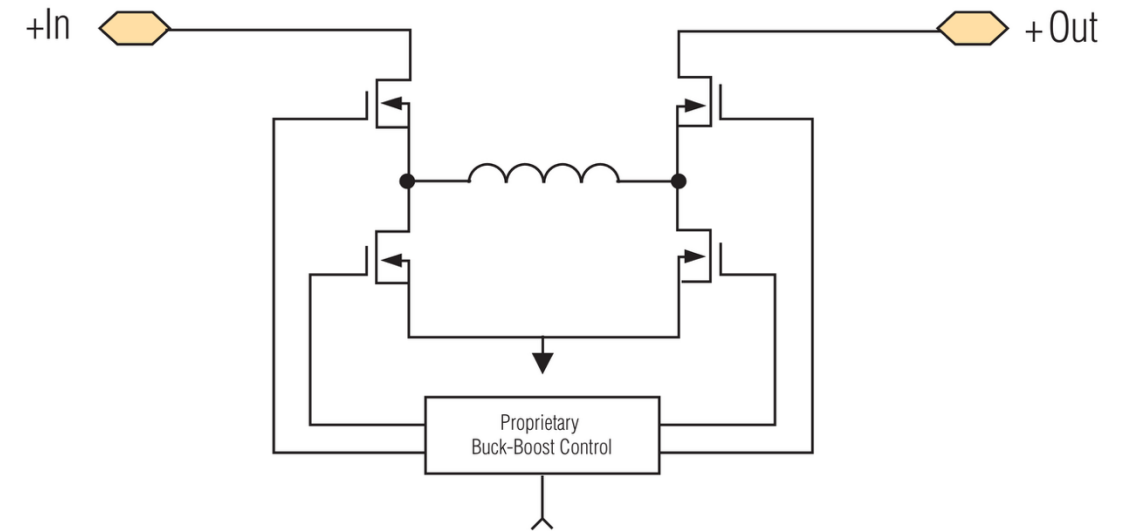
Sine Amplitude Converter (SAC)

- Almost no switch loss: peak efficiency 99%
- Extremely high switching frequency up to 2MHz
- Soft switching for main power circuit and drive circuit
- Excellent EMI performance: The best state without filters can pass CISPR25-Class3
- Common mode noise; Using common mode inductor and Y cap through the PE
- Fixed ratio output



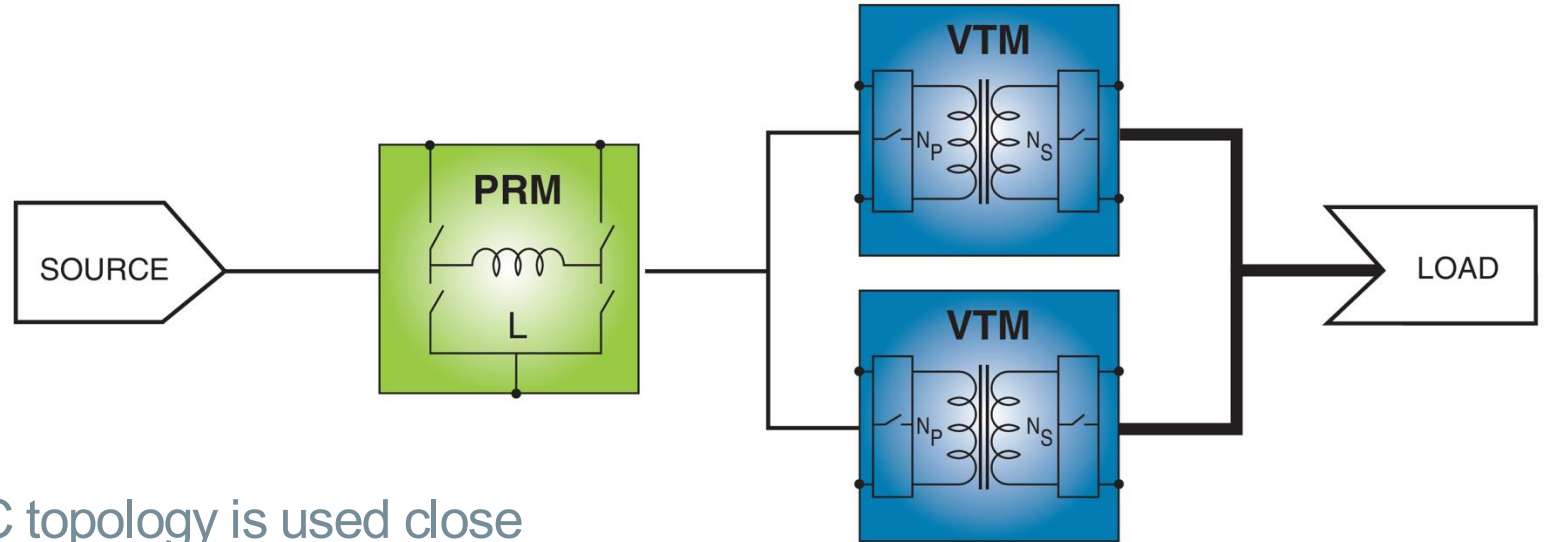
ZVS buck-boost regulator

- Almost no switching loss: efficiency up to 99%
- Extremely high switching frequency: operating frequency up to 2MHz
- Low inductance current
- All MOSFET are working with soft switching (ZVS)
- Differential noise / use differential inductor and differential Caps.
- Adjustable output
- Compatible with SAC module, providing non-standard output for the testing machine industry

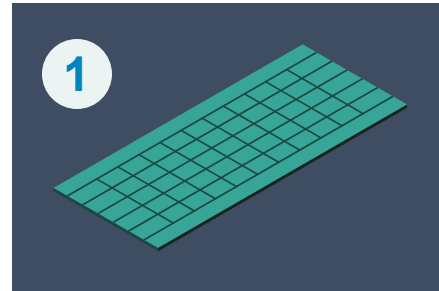


Factorized Power Architecture™ (FPA)

- Up to 97% efficiency
- Low PCB loss: small bus current, high current close to load, and short PCB path for high current
- All MOSFET are working with soft switching (ZVS)
- Low noise performance: SAC topology is used close to the load, with minimal impact on the load
- Adjustable output for non-standard voltages widely used in the ATE industry
- Modular design (PRM and VTM) can be adjusted separately to meet different inputs and outputs.
- 3.5mm low profile

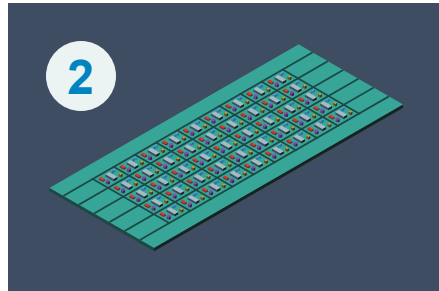


Advanced manufacturing process



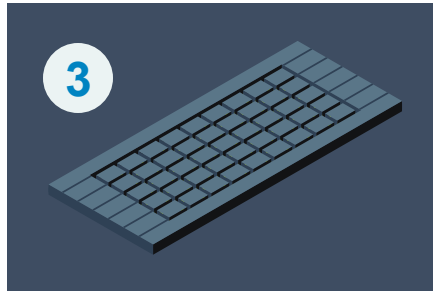
1
Bare panel

The process begins with a bare panel, ready for multiple instances of the same high-performance module, analogous to a silicon wafer



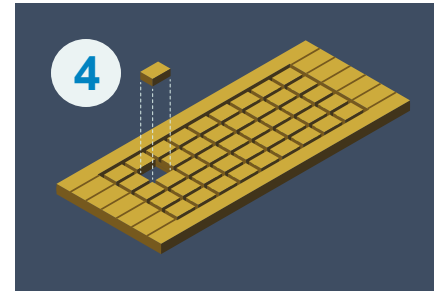
2
Surface mounting

High-quality power components, including magnetics, are mounted and soldered via state-of-the-art pick-and-place tools



3
Overmolding

A plastic compound encases the panel, protecting the components and creating a flat surface that makes the final product easier to handle



4
Plating

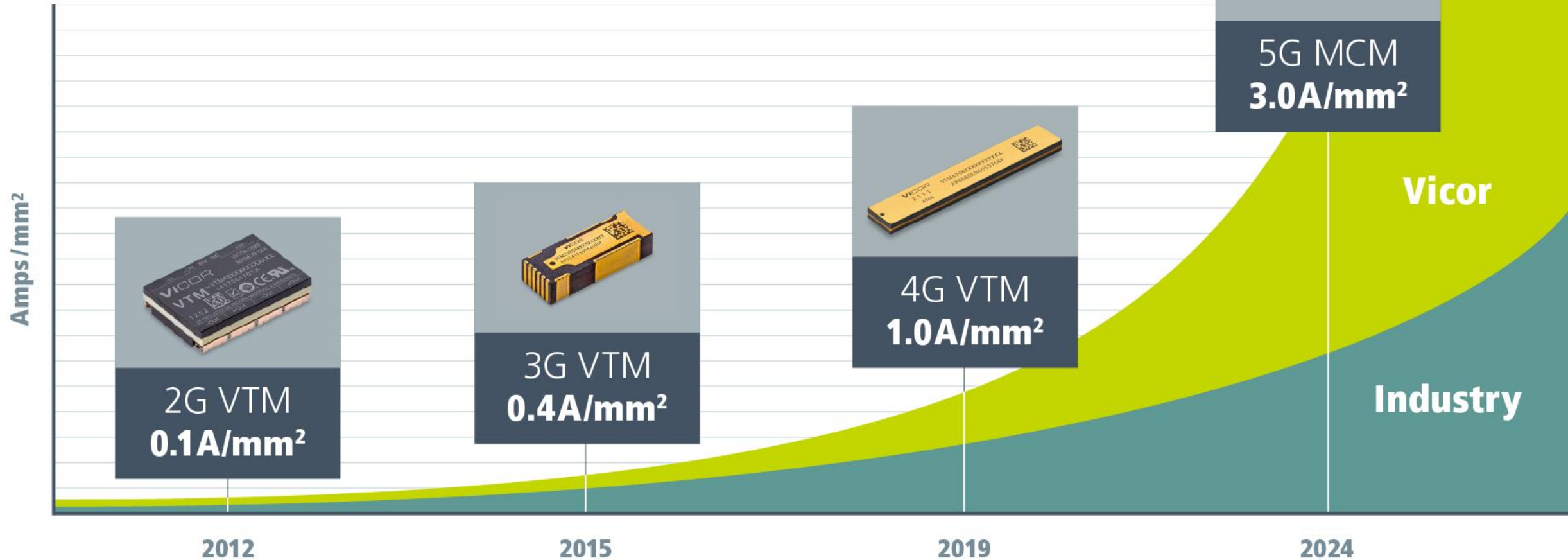
Heat conducting metals are plated onto the panel to enable a thermally efficient and reliable finished product



5
CHiP modules

Split the individual modules and tested for conformance to data sheet specifications

Continually providing the highest density power solutions



Advanced Manufacturing

■ Vicor has 40+ years of proven quality and reliability supporting demanding applications

- AI computing
- Automotive
- Industrial
- Defense

■ Vertically integrated manufacturing

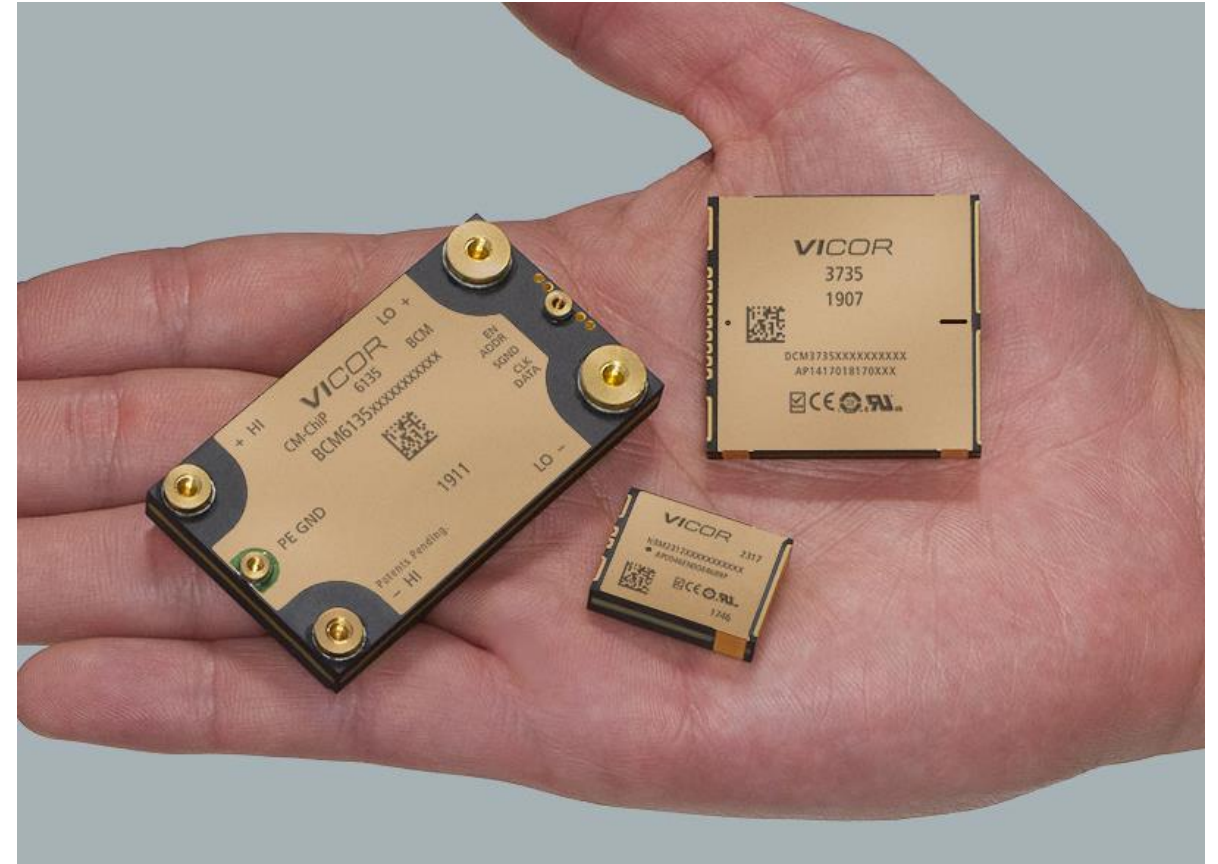
- TS16949
- ISO ..
- List certifications



Vicor vertically integrated ChiP
fab in Andover, MA USA

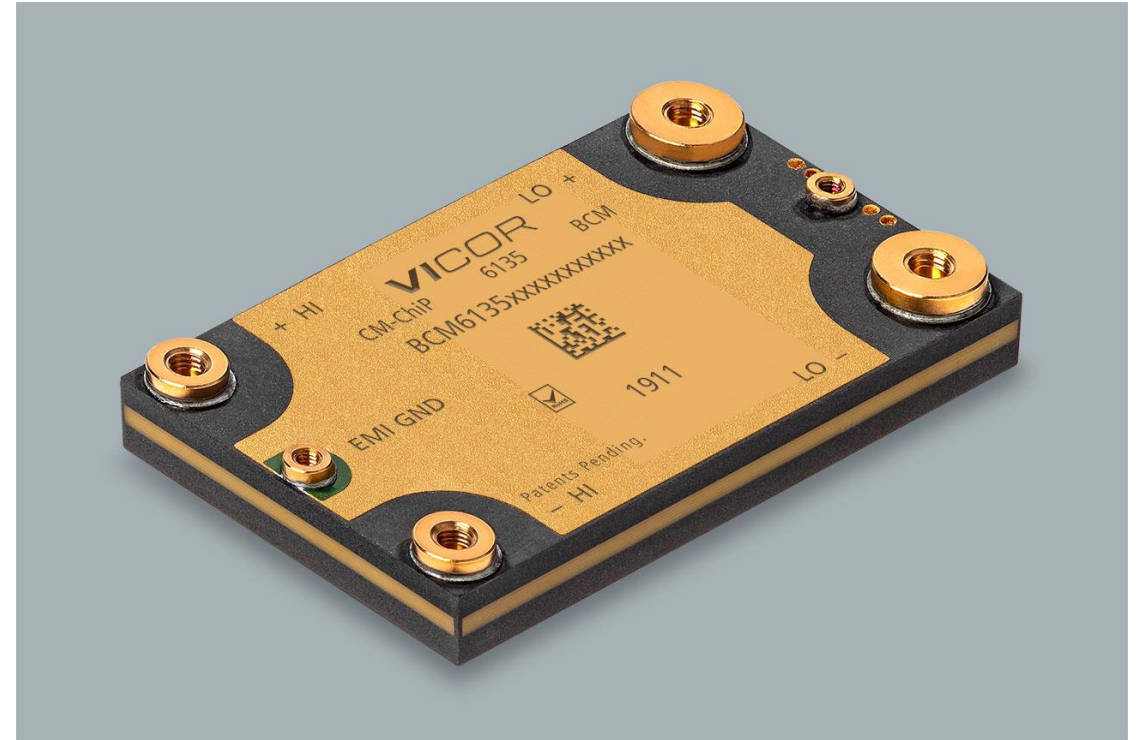
High Performance Power Modules

- Highest power density
 - Up to 10 kW/in³
 - Up to 173 W/g
- Highest efficiency
 - Up to 99%
- Highest flexibility and scalability
 - Complete modular solution



BCM6135CD1E5165T00 isolated, fixed-ratio (8:1) bus converter

- Vin: 260 – 410V
- Vout: 32.5 – 51.3V
- IO_{UT} (avg): 65 A
- Peak Efficiency: 97.9%
- Parallel capable
- PMBus programmable
- 4242VDC Isolation
- 61.33 x 35.35 x 7.42 mm



PRM2610S55D60F0TL0 non-isolated regulator

- PRM regulation for downstream VTM
- Adapted Loop Control
- VIN (full power): 43V – 55V, 48VNOM
- VOUT: 20V – 60V, 48VNOM
- POUT (avg): 600W, VIN > 43V
- Efficiency: 98.5%
- Programmable soft start
- PMBus programmable
- SM-CHiP surface mount package
- 26.1 x 9.8 x 3.5mm



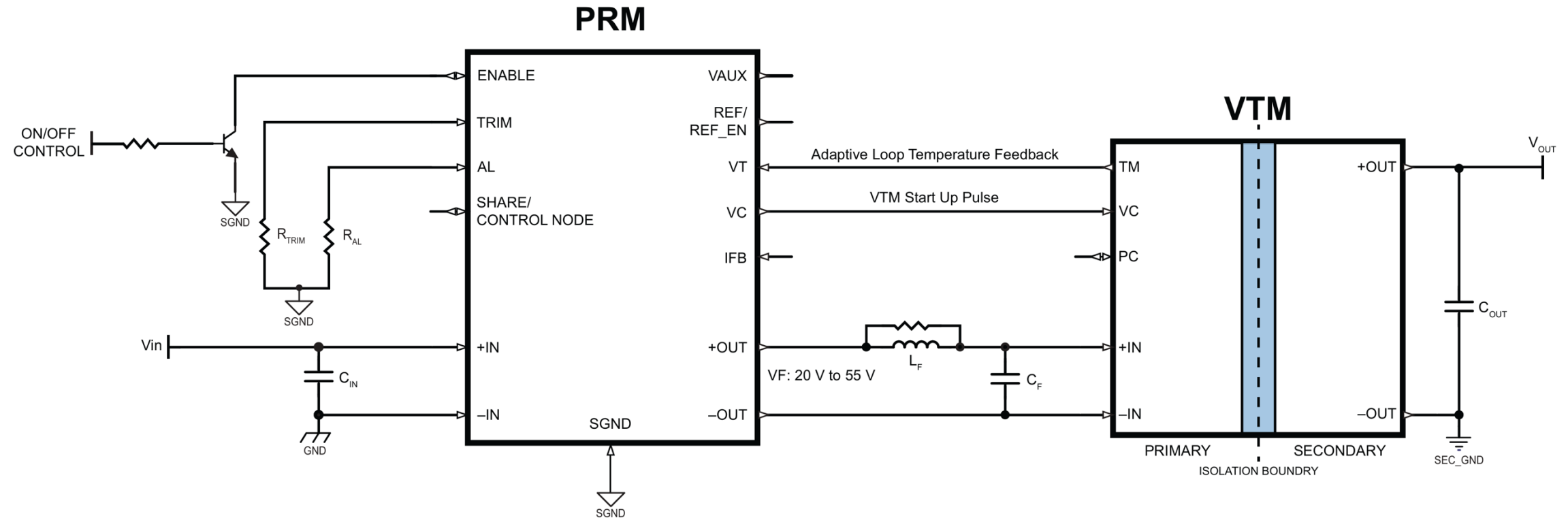
VTM3110 (different K Factors) isolated, fixed-ratio DC-DC converter

- VIN: 20 – 60V
- VOUT: 10 – 30V, 24VNOM (example K=1/2)
- IOUT (avg): 15A
- IOUT (peak): 22.5A (10ms duration)
- Target efficiency: 96.5%
- Parallel capable
- 550V isolation
- Stackable (150V max working voltage)
- Inrush current control
- All VTMs packaged in 31.1 x 9.8 x 3.5mm SM-ChiP surface mount package



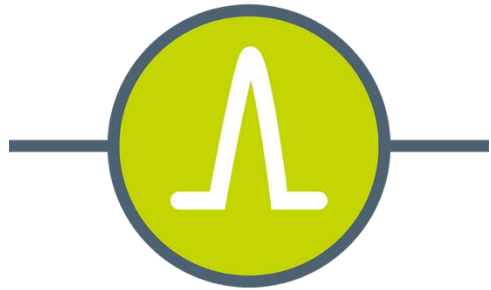
Multiple VTM modules, top picture is VTM3408 closest to VTM3110 size

Detailed Isolated PRM/VTM application



ITRIM will be connected to ground with a resistor and will be set at maximum. User can trim is down as desired. VTRIM can be connected with a pull-up (connect to OUT) or pull-down resistor (connect to SGND). User can trim it down or up as desired

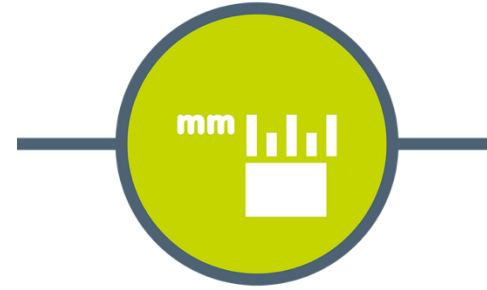
The value Vicor brings



Fast transience
Response



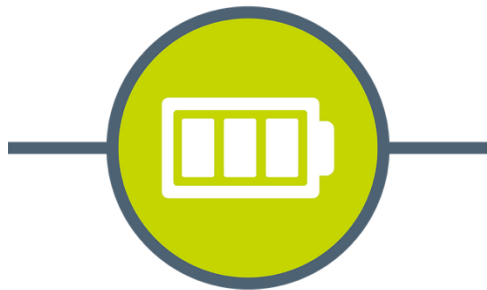
Lightweight



Power density



Faster time to market



Optimize storage
performance



High efficiency



High reliability



Thank you